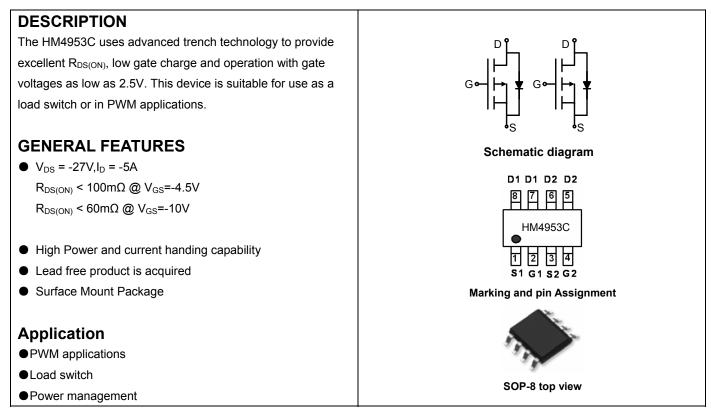
Dual P-Channel Enhancement Mode Power MOSFET



Package Marking And Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
HM4953C	HM4953C	SOP-8	Ø180mm	8 mm	3000 units

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	-27	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	I _D	-5	A
Drain Current -Pulsed (Note 1)	I _{DM}	-20	A
Maximum Power Dissipation	PD	1	W
Operating Junction and Storage Temperature Range	TJ,TSTG	-55 To 150	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Ambient (Note 2)	R _{0JA}	125	°C /W
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Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250µA	-27	-30	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-20V,V _{GS} =0V	-	-	-1	μA

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Gate-Body Leakage Current	I _{GSS}	V_{GS} =±10V, V_{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	·			•		
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =-250µA	-0.5	-1.1	-1.7	V
Drain-Source On-State Resistance	P	V _{GS} =-4.5V, I _D =-4A	-	65	100	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-10V, I _D =-5A	-	52	60	mΩ
Forward Transconductance	g fs	V _{DS} =-5V,I _D =-2.8A	-	9.5	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}	(-10)(1)(-0)(-0)(-0)(-0)(-0)(-0)(-0)(-0)(-0)(-0	-	405	-	PF
Output Capacitance	Coss	V _{DS} =-10V,V _{GS} =0V, F=1.0MHz	-	75	-	PF
Reverse Transfer Capacitance	Crss		-	55	-	PF
Switching Characteristics (Note 4)	·			•		
Turn-on Delay Time	t _{d(on)}		-	11	-	nS
Turn-on Rise Time	tr	V _{DD} =-10V,I _D =-1A	-	35	-	nS
Turn-Off Delay Time	t _{d(off)}	V _{GS} =-4.5V,R _{GEN} =10Ω	-	30	-	nS
Turn-Off Fall Time	t _f		-	10	-	nS
Total Gate Charge	Qg)/ <u>40)/</u> / 0.4	-	3.3	12	nC
Gate-Source Charge	Q _{gs}	V _{DS} =-10V,I _D =-3A, V _{GS} =-2.5V	-	0.7	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =-2.5V	-	1.3	-	nC
Drain-Source Diode Characteristics			•	•	•	
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =1.3A	-	-	-1.2	V
Diode Forward Current (Note 2)	Is		_	-	-1.3	А

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, $t \le 10$ sec.

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

4. Guaranteed by design, not subject to production

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

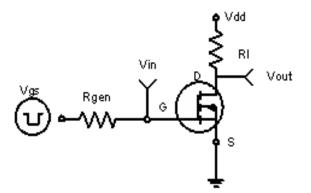
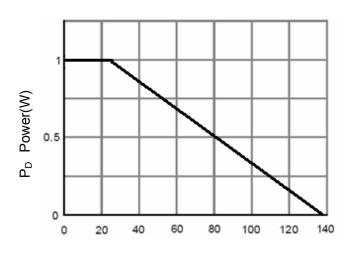
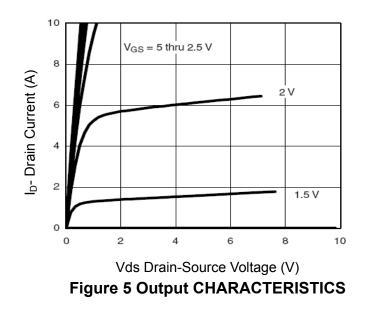
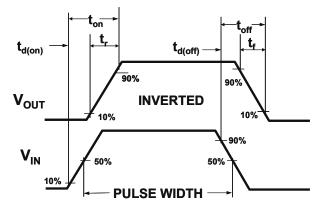


Figure 1:Switching Test Circuit

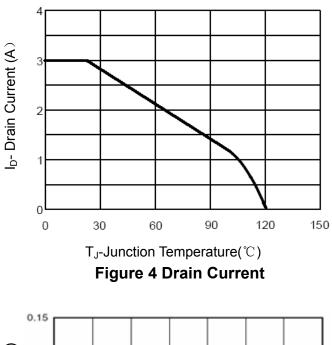


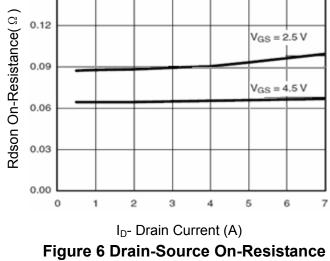
T_J-Junction Temperature(℃) Figure 3 Power Dissipation





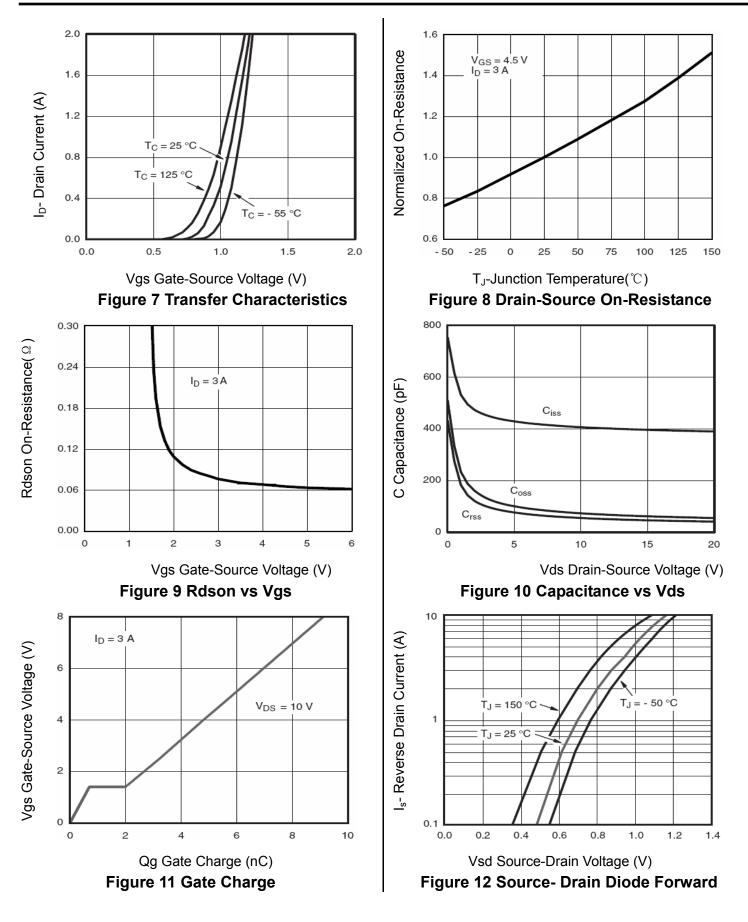






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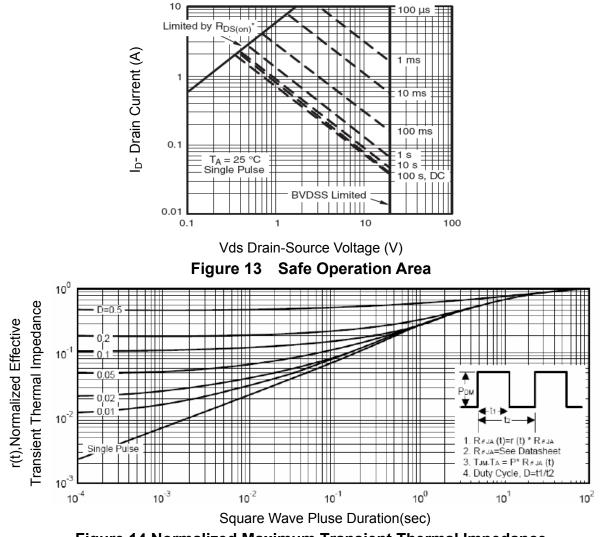
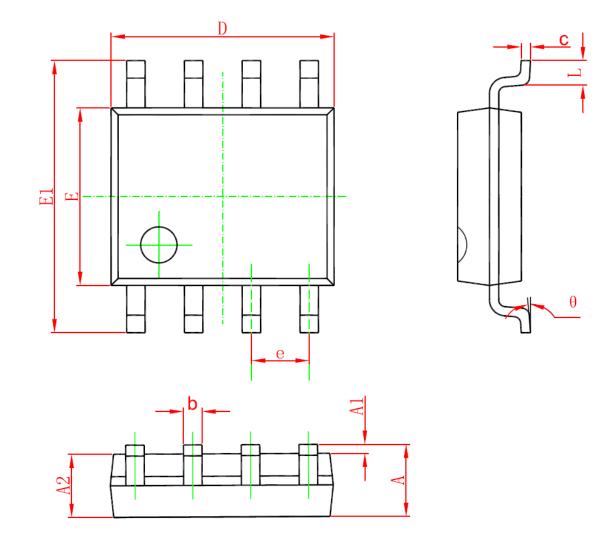


Figure 14 Normalized Maximum Transient Thermal Impedance

SOP8 PACKAGE OUTLINE DIMENSIONS



Court of	Dimensions Ir	n Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
A	1.350	1. 750	0. 053	0.069	
A1	0. 100	0. 250	0.004	0.010	
A2	1.350	1. 550	0. 053	0.061	
b	0. 330	0. 510	0. 013	0. 020	
С	0. 170	0. 250	0.006	0.010	
D	4. 700	5. 100	0. 185	0. 200	
E	3.800	4. 000	0. 150	0. 157	
E1	5.800	6. 200	0. 228	0. 244	
e	1.270	(BSC)	0. 050 (BSC)		
Ĺ	0. 400	1. 270	0.016	0.050	
θ	0°	8°	0°	8°	

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